

Smart High-Side Power Switch

Smart High-Side Power Switch

PROFET BTS711L1

Data Sheet

Rev 1.3, 2012-01-16

Automotive Power



Smart Four Channel Highside Power Switch

Features

- Overload protection
- Current limitation
- Short-circuit protection
- Thermal shutdown
- Overvoltage protection (including load dump)
- Fast demagnetization of inductive loads
- Reverse battery protection¹⁾
- Undervoltage and overvoltage shutdown with auto-restart and hysteresis
- Open drain diagnostic output
- Open load detection in ON-state
- CMOS compatible input
- Loss of ground and loss of V_{bb} protection
- Electrostatic discharge (ESD) protection

Application

- μC compatible power switch with diagnostic feedback for 12 V and 24 V DC grounded loads
- All types of resistive, inductive and capacitive loads
- Replaces electromechanical relays and discrete circuits

AEC qualified

Green product (RoHS compliant) **General Description**

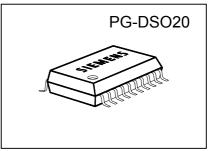
N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, monolithically integrated in Smart SIPMOS® technology. Providing embedded protective functions.

Pin Definitions and Functions

Pin	Symbol	Function
1,10,	V_{bb}	Positive power supply voltage. Design the
11,12,		wiring for the simultaneous max. short circuit
15,16,		currents from channel 1 to 4 and also for low
19,20		thermal resistance
3	IN1	Input 1 4, activates channel 1 4 in case of
5	IN2	logic high signal
7	IN3	
9	IN4	
18	OUT1	Output 1 4, protected high-side power output
17	OUT2	of channel 1 4. Design the wiring for the
14	OUT3	max. short circuit current
13	OUT4	
4	ST1/2	Diagnostic feedback 1/2 of channel 1 and
		channel 2, open drain, low on failure
8	ST3/4	Diagnostic feedback 3/4 of channel 3 and
		channel 4, open drain, low on failure
2	GND1/2	Ground 1/2 of chip 1 (channel 1 and channel 2)
6	GND3/4	Ground 3/4 of chip 2 (channel 3 and channel 4)

Product Summary

· ·				
Overvoltage Protection	$V_{\rm bb(AZ)}$)	43	٧
Operating voltage	V _{bb(on}		0 34	V
active channels:	one	two parallel	four parallel	
On-state resistance RON	200	100	50	$m\Omega$
Nominal load current I _{L(NOM)}	1.9	2.8	4.4	Α
Current limitation I _{L(SCr)}	4	4	4	Α







Pin configuration (top view)

_				-
V_{bb}	1	•	20	V_{bb}
GND1/2	2		19	V_{bb}
IN1	3		18	OUT1
ST1/2	4		17	OUT2
IN2	5		16	V_{bb}
GND3/4	6		15	V_{bb}
IN3	7		14	OUT3
ST3/4	8		13	OUT4
IN4	9		12	V_{bb}
V_{bb}	10		11	V_{bb}

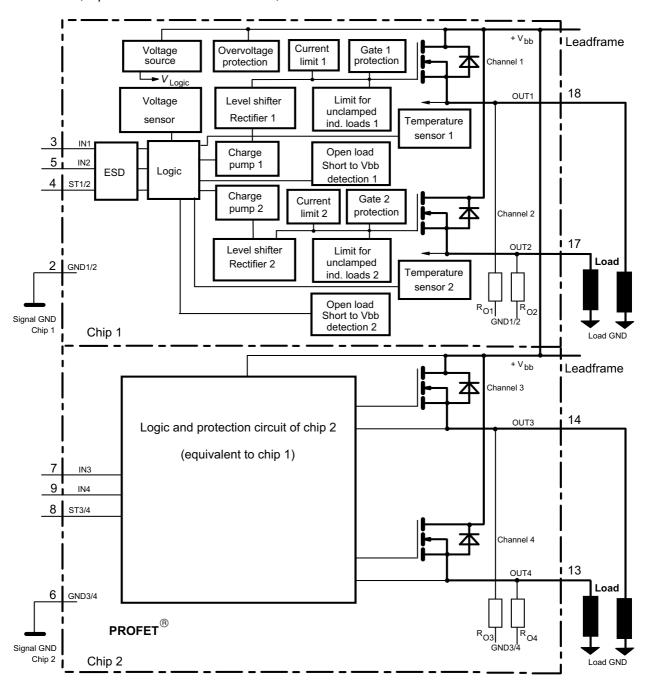
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With external current limit (e.g. resistor R_{GND}=150 Ω) in GND connection, resistor in series with ST connection, reverse load current limited by connected load.



Block diagram

Four Channels; Open Load detection in on state;



Leadframe connected to pin 1, 10, 11, 12, 15, 16, 19, 20

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Maximum Ratings at $T_j = 25$ °C unless otherwise specified

Parameter		Symbol	Values	Unit
Supply voltage (overvoltage prot	$V_{ m bb}$	43	V	
Supply voltage for full short circut, $T_{j,\text{start}} = -40 + 150^{\circ}\text{C}$	it protection	V _{bb}	34	V
Load current (Short-circuit currer	nt, see page 5)	I ∟	self-limited	Α
Load dump protection ²⁾ V_{LoadDump} $R_{\text{l}^{3)}} = 2 \Omega$, $t_{\text{d}} = 200 \text{ ms}$; $\text{IN} = \text{low}$ each channel loaded with $R_{\text{L}} = 100 \text{ ms}$	or high,	V _{Load} dump ⁴⁾	60	V
Operating temperature range		Tj	-40+150	°C
Storage temperature range		T_{stg}	-55+150	
Power dissipation (DC) ⁵	<i>T</i> _a = 25°C:	P _{tot}	3.6	W
(all channels active)	$T_{\rm a} = 85^{\circ}{\rm C}$:		1.9	
Inductive load switch-off energy $V_{bb} = 12V$, $T_{j,start} = 150^{\circ}C^{5}$,	dissipation, single pulse			
$I_{L} = 1.9 \text{ A}, Z_{L} = 66 \text{ mH}, 0 \Omega$	one channel:	<i>E</i> _{AS}	150	mJ
$I_{L} = 2.8 \text{ A}, Z_{L} = 66 \text{ mH}, 0 \Omega$	two parallel channels:		320	
$I_{L} = 4.4 \text{ A}, Z_{L} = 66 \text{ mH}, 0 \Omega$	four parallel channels:		800	
see diagrams on page 9 and page 10				
Electrostatic discharge capability (Human Body Model)	(ESD)	V _{ESD}	1.0	kV
Input voltage (DC)		V _{IN}	-10 +16	V
Current through input pin (DC)		I _{IN}	±2.0	mA
Current through status pin (DC)	I _{ST}	±5.0		
see internal circuit diagram page 8				
Thermal resistance				
junction - soldering point ^{5),6)}	each channel:	R_{this}	16	K/W
junction - ambient ⁵⁾	one channel active:	R_{thia}	44	
-	all channels active:		35	

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Supply voltages higher than $V_{bb(AZ)}$ require an external current limit for the GND and status pins, e.g. with a 150 Ω resistor in the GND connection and a 15 k Ω resistor in series with the status pin. A resistor for input protection is integrated.

³⁾ $R_{\rm I}$ = internal resistance of the load dump test pulse generator

 $^{^{4)}}$ V_{Load dump} is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

⁵⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for V_{bb} connection. PCB is vertical without blown air. See page 15

⁶⁾ Soldering point: upper side of solder edge of device pin 15. See page 15



Electrical Characteristics

$T_{j} = 150^{\circ}\text{C:} \qquad 320 400$ two parallel channels, $T_{j} = 25^{\circ}\text{C:}$ four parallel channels, $T_{j} = 25^{\circ}\text{C:}$ $42 50$ Nominal load current one channel active: two parallel channels active: four parallel channels active: $2.6 2.8 41 4.4 4$	Parameter and Conditions, each of the four channels at T _j = 25 °C, V _{bb} = 12 V unless otherwise specified			Symbol		Unit		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$					min	typ	max	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$								
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Load Switching Capabil	ities and Cha	racteristics					
$T_j = 150^{\circ}\text{C:} \\ \text{two parallel channels,} T_j = 25^{\circ}\text{C:} \\ \text{four parallel channels,} T_j = 25^{\circ}\text{C:} \\ \text{four parallel channels,} T_j = 25^{\circ}\text{C:} \\ \text{Nominal load current} \\ \text{two parallel channels active:} \\ \text{two parallel channels active:} \\ \text{four parallel channels active:} \\ \text{dup;} V_{bb} = 30^{\circ}\text{C,} T_j \leq 150^{\circ}\text{C} \\ \text{Output current while GND disconnected or pulled} \\ \text{up;} V_{bb} = 30^{\circ}\text{V,} V_{IN} = 0, \text{ see diagram page 9} \\ \text{Turn-on time} \qquad \text{to } 90\% V_{OUT:} \\ \text{Turn-off time} \qquad \text{to } 10\% V_{OUT:} \\ \text{R}_L = 12^{\circ}\Omega, T_j = -40 + 150^{\circ}\text{C:} \\ \text{Slew rate on} \\ \text{10 to } 30\% V_{OUT,} R_L = 12^{\circ}\Omega, \qquad T_j = -40 + 150^{\circ}\text{C:} \\ \text{Slew rate off} \\ \text{70 to } 40\% V_{OUT,} R_L = 12^{\circ}\Omega, \qquad T_j = -40 + 150^{\circ}\text{C:} \\ \text{Undervoltage shutdown} \qquad T_j = -40 + 150^{\circ}\text{C:} \\ \text{V}_{bb(under)} \qquad 3.5 \qquad \\ \text{5.0} \\ \text{Undervoltage restart} \qquad T_j = -40 + 150^{\circ}\text{C:} \\ \text{V}_{bb(urst)} \qquad \\ \text{V}_{bb(urst)} \qquad \\ \text{5.0} \\ \text{V}_{DU} = 0.1 \qquad \\ \text{Cundervoltage restart of charge pump see diagram page 14} \qquad T_j = -40 + 150^{\circ}\text{C:} \\ \text{Undervoltage shutdown} \qquad T_j = -40 + 150^{\circ}\text{C:} \\ \text{Undervoltage physteresis} \\ \Delta V_{bb(under)} \qquad \\ \Delta V_{bb(under)} \qquad \\ \text{V}_{bb(urder)} \qquad \\ \text{O.2} \qquad$	On-state resistance (V _{bb}	to OUT)						
two parallel channels, $T_j = 25^{\circ}\text{C}$: four parallel channels, $T_j = 25^{\circ}\text{C}$: $42 \times 50 \times 5$	I _L = 1.8 A eac	ch channel,	$T_{\rm j}$ = 25°C:	Ron		165	200	mΩ
four parallel channels, $T_j = 25^{\circ}\text{C}$:			$T_{\rm j}$ = 150°C:			320	400	
four parallel channels, $T_j = 25^{\circ}\text{C}$:	two para	llel channels	$T_i = 25^{\circ}\text{C}$:			83	100	
Nominal load current one channel active: two parallel channels active: four parallel channels active: four parallel channels active: $2.6 2.8 2.8 2.6 2.8 2.6 2.8 3.6 2.8 3.6 2.8 3.6 2.8 3.0 3.0 3.0 3.0 3.0 3.0 3.0 3.0 3.0 3.0$	<u>. </u>		•					
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				I _{L(NOM)}	1.7			Α
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				E(NOW)				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		•				4.4		
		•						
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				I _{L (GNDhiah)}			10	mA
Turn-off time to $10\%\ V_{\text{OUT}}$: t_{off} 80 200 400 $R_{\text{L}} = 12\ \Omega,\ T_{\text{j}} = -40 + 150^{\circ}\text{C}$ Slew rate on $0.1 \text{ or } 0.1 $	up; $V_{bb} = 30 \text{ V}, V_{IN} = 0,$	see diagram p	page 9	_(0.12g.)				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Turn-on time	to	90% V _{OUT} :	$t_{\sf on}$	80	200	400	μs
Slew rate on 10 to 30% V_{OUT} , R_{L} = 12 Ω, T_{j} =-40+150°C:	Turn-off time	to	10% <i>V</i> _{ОUТ} :	$t_{ m off}$	80	200	400	
10 to 30% V_{OUT} , $R_{\text{L}} = 12 \Omega$, $T_{\text{j}} = -40 + 150 ^{\circ}\text{C}$: Slew rate off 70 to 40% V_{OUT} , $R_{\text{L}} = 12 \Omega$, $T_{\text{j}} = -40 + 150 ^{\circ}\text{C}$: Operating Parameters Operating voltage ⁷) $T_{\text{j}} = -40 + 150 ^{\circ}\text{C}$: $V_{\text{bb(on)}}$ 5.0 34 Undervoltage shutdown $T_{\text{j}} = -40 + 150 ^{\circ}\text{C}$: $V_{\text{bb(under)}}$ 3.5 5.0 Undervoltage restart $T_{\text{j}} = -40 + 25 ^{\circ}\text{C}$: $V_{\text{bb(u rst)}}$ 5.0 $T_{\text{j}} = +150 ^{\circ}\text{C}$: Undervoltage restart of charge pump see diagram page 14 $T_{\text{j}} = -40 + 150 ^{\circ}\text{C}$: $V_{\text{bb(ucp)}}$ 5.6 7.0 Undervoltage hysteresis $\Delta V_{\text{bb(under)}} = V_{\text{bb(u rst)}} - V_{\text{bb(under)}}$ 0.2 $\Delta V_{\text{bb(under)}} = V_{\text{bb(u rst)}} - V_{\text{bb(under)}}$ Overvoltage shutdown $T_{\text{j}} = -40 + 150 ^{\circ}\text{C}$: $V_{\text{bb(over)}}$ 34 43	$R_L = 12 \Omega, T_j = -40+150$	°C						
Slew rate off 70 to 40% V_{OUT} , $R_{\text{L}} = 12\Omega$, $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $-\text{d}V/\text{dt}_{\text{off}}$ 0.1 1 V/μ Operating Parameters Operating voltage ⁷⁾ $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $V_{\text{bb(on)}}$ 5.0 34 Undervoltage shutdown $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $V_{\text{bb(under)}}$ 3.5 5.0 Undervoltage restart $T_{\text{j}} = -40 + 25^{\circ}\text{C}$: $V_{\text{bb(u rst)}}$ 5.0 $T_{\text{j}} = +150^{\circ}\text{C}$: $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $T_{\text{j}} = -40 + 150^{\circ}C$	Slew rate on			dV/dt _{on}	0.1		1	V/μs
Slew rate off 70 to 40% V_{OUT} , $R_{\text{L}} = 12\Omega$, $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $-\text{d}V/\text{dt}_{\text{off}}$ 0.1 1 V/μ Operating Parameters Operating voltage ⁷⁾ $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $V_{\text{bb}(\text{on})}$ 5.0 34 Undervoltage shutdown $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $V_{\text{bb}(\text{under})}$ 3.5 5.0 Undervoltage restart $T_{\text{j}} = -40 + 25^{\circ}\text{C}$: $V_{\text{bb}(\text{u rst})}$ 5.0 To see diagram page 14 $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $V_{\text{bb}(\text{ucp})}$ 5.6 To Undervoltage hysteresis $\Delta V_{\text{bb}(\text{under})} = V_{\text{bb}(\text{u rst})} - V_{\text{bb}(\text{under})}$ Overvoltage shutdown $T_{\text{j}} = -40 + 150^{\circ}\text{C}$: $V_{\text{bb}(\text{over})}$ 34 43	10 to 30% V_{OUT} , $R_L = 12$	Ω , $T_{\rm j} = -4$	0+150°C:					
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				-dV/dt _{off}	0.1		1	V/µs
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$					•	*		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Operating Parameters							
Undervoltage restart T_j =-40+25°C: $V_{bb(u rst)}$ 5.0 7.0 Undervoltage restart of charge pump see diagram page 14 T_j =-40+150°C: $V_{bb(ucp)}$ 5.6 7.0 Undervoltage hysteresis $\Delta V_{bb(under)}$ 0.2 Overvoltage shutdown T_j =-40+150°C: $V_{bb(over)}$ 34 43	Operating voltage ⁷⁾	$T_{\rm j} = -4$	0+150°C:	$V_{ m bb(on)}$	5.0		34	V
$T_{j} = +150^{\circ}\text{C}: \qquad \qquad 7.0$ Undervoltage restart of charge pump see diagram page 14 $T_{j} = -40 + 150^{\circ}\text{C}: \qquad \qquad 5.6$ Undervoltage hysteresis $\Delta V_{bb(under)} = V_{bb(u \text{ rst})} - V_{bb(under)}$ Overvoltage shutdown $T_{j} = -40 + 150^{\circ}\text{C}: \qquad V_{bb(over)} \qquad 34 \qquad \qquad 43$	Undervoltage shutdown	$T_{\rm j} = -4$	0+150°C:	$V_{\rm bb(under)}$	3.5		5.0	V
	Undervoltage restart	$T_{\rm j} = -$	40+25°C:	V _{bb(u rst)}			5.0	V
see diagram page 14 T_j =-40+150°C: Undervoltage hysteresis $\Delta V_{bb(under)}$ 0.2 Overvoltage shutdown T_j =-40+150°C: $V_{bb(over)}$ 34 43		7	T _j =+150°C:				7.0	
$\Delta V_{bb(under)} = V_{bb(u rst)} - V_{bb(under)}$ Overvoltage shutdown $T_j = -40 + 150$ °C: $V_{bb(over)}$ 34 43		narge pump T _j =-4	0+150°C:	$V_{ m bb(ucp)}$		5.6	7.0	V
Overvoltage shutdown $T_j = -40 + 150$ °C: $V_{bb(over)}$ 34 43		(under)		$\Delta V_{ m bb(under)}$		0.2		V
			0+150°C:	V _{bb(over)}	34		43	V
	Overvoltage restart	$T_{\rm j}$ =-4	0+150°C:	V _{bb(o rst)}	33			V

*T*_i =-40...+150°C:

 $T_i = -40... + 150$ °C:

Overvoltage hysteresis

 $I_{bb} = 40 \text{ mA}$

Overvoltage protection⁸⁾

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 $\Delta V_{\text{bb(over)}}$

 $V_{\rm bb(AZ)}$

0.5

47

42

⁷⁾ At supply voltage increase up to V_{bb} = 5.6 V typ without charge pump, $V_{OUT} \approx V_{bb}$ - 2 V

⁸⁾ see also V_{ON(CL)} in circuit diagram on page 8.



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Parameter and Conditions, each of the four channels	Symbol	Values			Unit
at T _j = 25 °C, V _{bb} = 12 V unless otherwise specified		min	typ	max	
Standby surrent all shannels off T 05°C	1		20	60	^
Standby current, all channels off $T_j = 25$ °C: $V_{IN} = 0$ $T_i = 150$ °C:	I _{bb(off)}		28 44	60 70	μΑ
	,				^
Leakage output current (included in $I_{bb(off)}$) $V_{IN} = 0$	I _{L(off)}			12	μΑ
Operating current 9, $V_{IN} = 5V$, $T_j = -40+150$ °C					
$I_{\text{GND}} = I_{\text{GND1/2}} + I_{\text{GND3/4}},$ one channel on:	<i>I</i> _{GND}		2	3	mA
four channels on:			8	12	
Protection Functions ¹⁰⁾					
Initial peak short circuit current limit, (see timing diagrams, page 13)					
each channel, $\tau_i = -40^{\circ}$ C:	I _{L(SCp)}	5.5	9.5	13	Α
τ _i =25°C:	,	4.5	7.5	11	
τ _i =+150°C:		2.5	4.5	7	
two parallel channels	twice	the curre	nt of one	channel	
four parallel channels	four times	the curre	nt of one	channel	
Repetitive short circuit current limit,					
$T_{\rm i} = T_{\rm it}$ each channel	I _{L(SCr)}		4		Α
two parallel channels	_(00.)		4		
four parallel channels			4		
(see timing diagrams, page 13)					
Initial short circuit shutdown time $T_{i,start} = -40^{\circ}C$:	t _{off(SC)}		48		ms
$T_{i,start} = 25^{\circ}C$:			29		
(see page 11 and timing diagrams on page 13)					
Output clamp (inductive load switch off) ¹¹⁾ at V _{ON(CL)} = V _{bb} - V _{OUT}	V _{ON(CL)}		47		V
Thermal overload trip temperature	T _{it}	150			°C
Thermal hysteresis	$\Delta T_{\rm jt}$		10		K
Reverse Battery	,				
Reverse battery voltage 12)	- V _{bb}			32	V
Drain-source diode voltage (V _{out} > V _{bb}) <u>L</u> = -1.9 A, T _j = +150°C	-V _{ON}		610		mV

⁹⁾ Add I_{ST} , if $I_{ST} > 0$

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¹⁰⁾ Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

 $^{^{11)}}$ If channels are connected in parallel, output clamp is usually accomplished by the channel with the lowest $V_{ON(CL)}$

Requires a 150 Ω resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Note that the power dissipation is higher compared to normal operating conditions due to the voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Input and Status currents have to be limited (see max. ratings page 3 and circuit page 8).



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Parameter and Conditions, eac	Symbol		Values		Unit	
at T _j = 25 °C, V_{bb} = 12 V unless otherw	ise specified		min	typ	max	
Diagnostic Characteristics						
Open load detection current, (on-	condition)					
each ch	annel, $T_j = -40$ °C:	I _{L (OL)}	10		200	mA
	$T_{\rm j} = 25^{\circ}{\rm C}$:		10		150	
	$T_{\rm j} = 150^{\circ}{\rm C}$:		10		150	
two	parallel channels	twice	the curre	nt of one	channel	
fou	r parallel channels	four times	the curre	nt of one	channel	
Open load detection voltage ¹³)	<i>T</i> _j =-40+150°C:	$V_{OUT(OL)}$	2	3	4	V
Internal output pull down (OUT to GND), V _{OUT} = 5 V	T _j =-40+150°C:	Ro	4	10	30	kΩ
Input and Status Feedback ¹⁴⁾						
Input resistance		R_{I}	2.5	3.5	6	kΩ
(see circuit page 8)	$T_{\rm j}$ =-40+150°C:					
Input turn-on threshold voltage	T _j =-40+150°C:	$V_{IN(T^+)}$	1.7		3.5	V
Input turn-off threshold voltage	T _j =-40+150°C:	$V_{IN(T-)}$	1.5			V
Input threshold hysteresis		$\Delta V_{IN(T)}$		0.5	-	V
Off state input current $T_j = -40+150$ °C:	$V_{IN} = 0.4 \text{ V}$:	I _{IN(off)}	1		50	μΑ
On state input current $T_j = -40+150$ °C:	V _{IN} = 5 V:	I _{IN(on)}	20	50	90	μΑ
Delay time for status with open to off (other channel in off state) (see timing diagrams, page 13),	oad after switch $T_{j} = -40+150^{\circ}C:$	t _{d(ST OL4)}	100	320	800	μs
Delay time for status with open lo off (other channel in on state) (see timing diagrams, page 13),	oad after switch $T_{j} = -40+150^{\circ}C:$	$t_{ exttt{d(ST OL5)}}$		5	20	μs
Status invalid after positive input	slope	$t_{\sf d(ST)}$		200	600	μs
(open load)	$T_{\rm j}$ =-40+150°C:					
Status output (open drain)	•					
Zener limit voltage $T_i = -40+150$	$^{\circ}$ C, I_{ST} = +1.6 mA:	$V_{\rm ST(high)}$	5.4	6.1		V
- •	$^{\circ}$ C, I_{ST} = +1.6 mA:	$V_{\rm ST(low)}$			0.4	
$T_{\rm i} = +150$	$^{\circ}$ C, I_{ST} = +1.6 mA:				0.6	

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¹³⁾ External pull up resistor required for open load detection in off state.

 $^{^{14)}\,}$ If ground resistors $R_{\mbox{\footnotesize GND}}$ are used, add the voltage drop across these resistors.



Truth Table

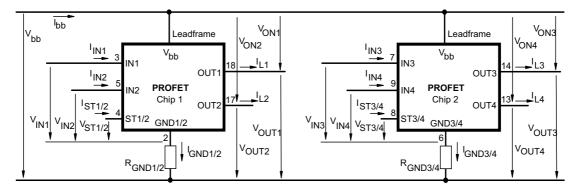
Channel 1 and 2	Chip 1	IN1	IN2	OUT1	OUT2	ST1/2	ST1/2
Channel 3 and 4	Chip 2	IN3	IN4	OUT3	OUT4	ST3/4	ST3/4
(equivalent to channel 1 and 2)							
						BTS 711L1	BTS 712N1
Normal operation		L	L	L	L	Н	Н
		L	Н	L	Н	Н	Н
		Н	L	Н	L	Н	Н
		Н	Н	Н	Н	Н	Н
Open load	Channel 1 (3)	L	L	Z	L	H(L ¹⁵⁾)	L
		L	Н	Z	Н	Н	Н
		Н	Х	Н	Х	L	Н
	Channel 2 (4)	L	L	L	Z	H(L ¹⁵⁾)	L
		Н	L	Н	Z	Н	Н
		Х	Н	Х	Н	L	H
Short circuit to V _{bb}	Channel 1 (3)	L	L	Н	L	L ¹⁶)	L ¹⁶⁾
		L	Н	Н	Н	Н	Н
		Н	Х	Н	Х	H(L ¹⁷⁾)	Н
	Channel 2 (4)	L	L	L	Н	<u>Ĺ</u> 16)	L ¹⁶)
	, ,	Н	L	Н	Н	H .	Н
		X	Н	X	Н	H(L ¹⁷⁾)	Н
Overtemperature	both channel	L	L	L	L	Н	Н
		X	Н	L	L	L	L
		Н	X	L	L	L	L
	Channel 1 (3)	L	X	L	Х	Н	Н
		Н	X	L	Х	L	L
	Channel 2 (4)	X	L	X	L	Н	Н
		Х	Н	Х	L	L	L
Undervoltage/ Overvoltage		X	X	L	L	Н	Н

L = "Low" Level H = "High" Level X = don't care

Z = high impedance, potential depends on external circuit Status signal valid after the time delay shown in the timing diagrams

Parallel switching of channel 1 and 2 (also channel 3 and 4) is easily possible by connecting the inputs and outputs in parallel (see truth table). If switching channel 1 to 4 in parallel, the status outputs ST1/2 and ST3/4 have to be configured as a 'Wired OR' function with a single pull-up resistor.

Terms



Leadframe (V_{bb}) is connected to pin 1,10,11,12,15,16,19,20

External R_{GND} optional; two resistors R_{GND1/2} ,R_{GND3/4} = 150 Ω or a single resistor R_{GND} = 75 Ω for reverse battery protection up to the max. operating voltage.

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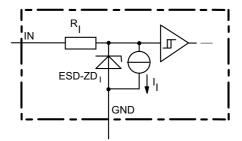
¹⁵⁾ With additional external pull up resistor

¹⁶⁾ An external short of output to V_{bb} in the off state causes an internal current from output to ground. If R_{GND} is used, an offset voltage at the GND and ST pins will occur and the V_{ST low} signal may be errorious.

Low resistance to $V_{\rm bb}$ may be detected by no-load-detection

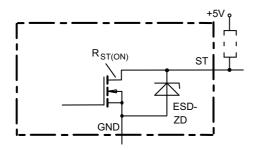


Input circuit (ESD protection), IN1...4



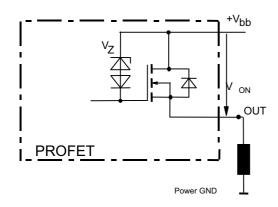
ESD zener diodes are not to be used as voltage clamp at DC conditions. Operation in this mode may result in a drift of the zener voltage (increase of up to 1 V).

Status output, ST1/2 or ST3/4



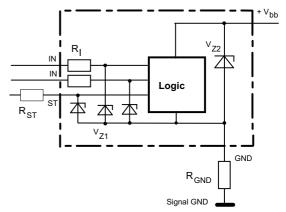
ESD-Zener diode: 6.1 V typ., max 5.0 mA; $R_{ST(ON)} < 380~\Omega$ at 1.6 mA, ESD zener diodes are not to be used as voltage clamp at DC conditions. Operation in this mode may result in a drift of the zener voltage (increase of up to 1 V).

Inductive and overvoltage output clamp, OUT1...4



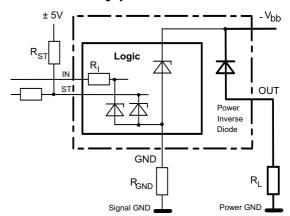
 $V_{\rm ON}$ clamped to $V_{\rm ON(CL)}$ = 47 V typ.

Overvoltage protection of logic part GND1/2 or GND3/4



 V_{Z1} = 6.1 V typ., V_{Z2} = 47 V typ., R_I = 3.5 k Ω typ., R_{GND} = 150 Ω

Reverse battery protection



 $R_{\text{GND}} = 150 \ \Omega, R_{\text{I}} = 3.5 \ \text{k}\Omega \text{ typ},$

Temperature protection is not active during inverse current operation.

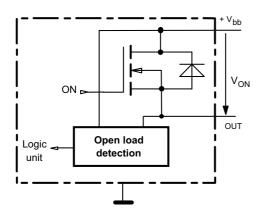
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Open-load detection, OUT1...4

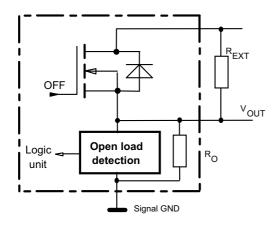
ON-state diagnostic condition:

 $V_{\text{ON}} < R_{\text{ON}} \cdot I_{L(\text{OL})}$; IN high



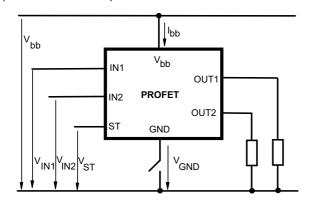
OFF-state diagnostic condition:

 $V_{OUT} > 3 \text{ V typ.}$; IN low



GND disconnect

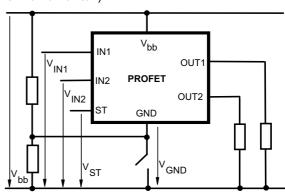
(channel 1/2 or 3/4)



Any kind of load. In case of IN = high is $V_{OUT} \approx V_{IN} - V_{IN(T+)}$. Due to $V_{GND} > 0$, no $V_{ST} = low$ signal available.

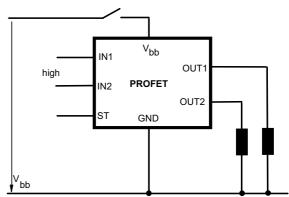
GND disconnect with GND pull up

(channel 1/2 or 3/4)



Any kind of load. If $V_{GND} > V_{IN} - V_{IN}(T+)$ device stays off Due to $V_{GND} > 0$, no $V_{ST} = low$ signal available.

V_{bb} disconnect with energized inductive load



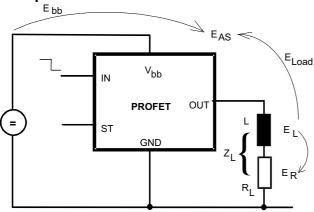
For an inductive load current up to the limit defined by E_{AS} (max. ratings see page 3 and diagram on page 10) each switch is protected against loss of V_{bb} .

Consider at your PCB layout that in the case of Vbb disconnection with energized inductive load the whole load current flows through the GND connection.

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Inductive load switch-off energy dissipation



Energy stored in load inductance:

$$E_L = \frac{1}{2} \cdot L \cdot I_1^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

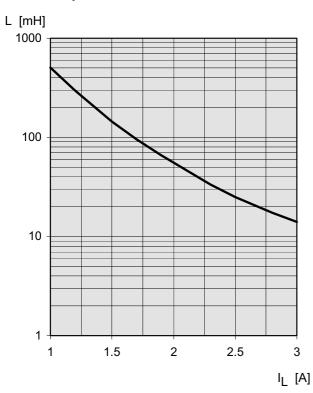
$$E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} \cdot i_L(t) dt$$

with an approximate solution for $R_L > 0 \Omega$:

$$E_{AS} = \frac{I_L \cdot L}{2 \cdot R_L} \left(V_{bb} + |V_{OUT(CL)}| \right) ln \left(1 + \frac{I_L \cdot R_L}{|V_{OUT(CL)}|} \right)$$

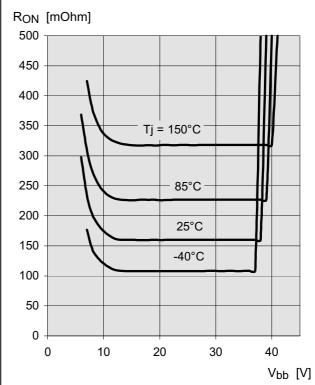
Maximum allowable load inductance for a single switch off (one channel)⁵⁾

$$L = f(I_L)$$
; T_{j,start} = 150°C, V_{bb} = 12 V, R_L = 0 Ω



Typ. on-state resistance

 $R_{ON} = f(V_{bb}, T_i)$; IL = 1.8 A, IN = high



Typ. open load detection current

 $I_{L(OL)} = f(V_{bb}, T_j);$ IN = high

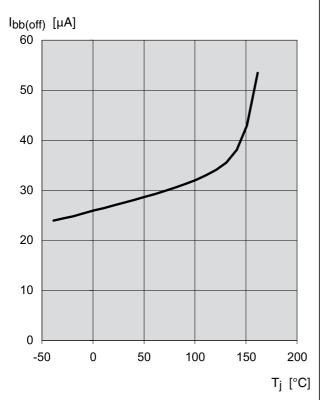
I_{L(OL)} [mA] 140 -40°C 120 25°C 100 load detection not specified 85°C 80 60 $T_i = 150^{\circ}C$ 40 20 0 0 20 25 30 5 10 15

V_{bb} [V]

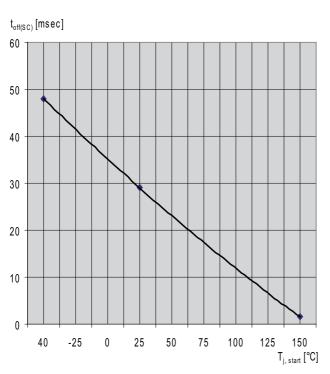


Typ. standby current

 $I_{bb(off)} = f(T_j); V_{bb} = 9...34 \text{ V}, IN1...4 = Iow$



Typ. initial short circuit shutdown time $t_{off(SC)} = f(T_{j,start})$; $V_{bb} = 12 \text{ V}$



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Timing diagrams

Timing diagrams are shown for chip 1 (channel 1/2). For chip 2 (channel 3/4) the diagrams are valid too. The channels 1 and 2, respectively 3 and 4, are symmetric and consequently the diagrams are valid for each channel as well as for permuted channels

Figure 1a: V_{bb} turn on:

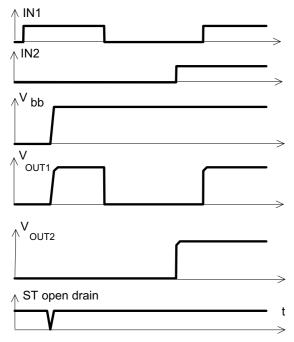
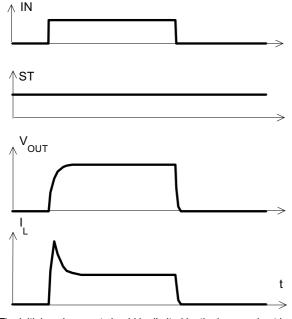
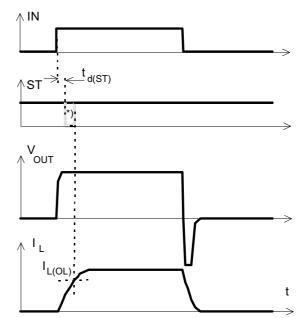


Figure 2a: Switching a lamp:



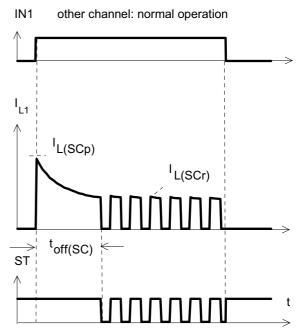
The initial peak current should be limited by the lamp and not by the initial short circuit current $I_{L(SCp)} = 7.5$ A typ. of the device.

Figure 2b: Switching an inductive load



*) if the time constant of load is too large, open-load-status may

Figure 3a: Turn on into short circuit: shut down by overtemperature, restart by cooling



Heating up of the chip may require several milliseconds, depending on external conditions ($t_{off(SC)}$ vs. $T_{j,start}$ see page 11)

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Figure 3b: Turn on into short circuit: shut down by overtemperature, restart by cooling (two parallel switched channels 1 and 2)

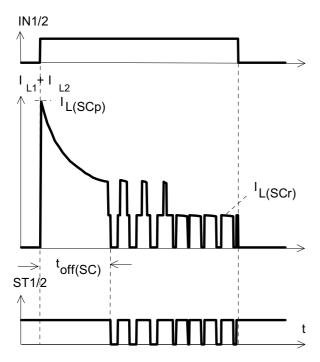


Figure 4a: Overtemperature: Reset if $T_j < T_{jt}$

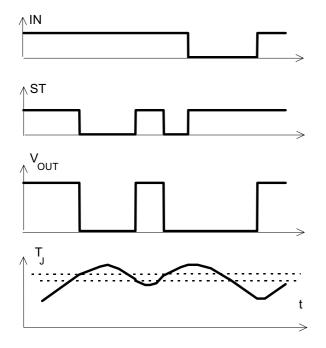


Figure 5a: Open load: detection in ON-state, open load occurs in on-state

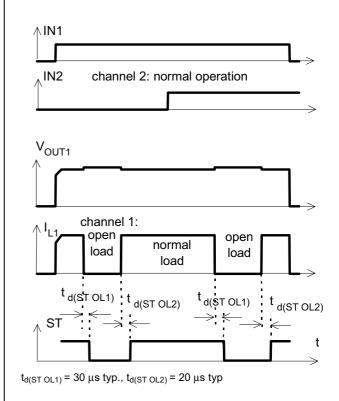
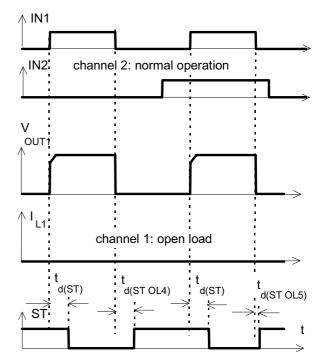


Figure 5b: Open load: detection in ON-state, turn on/off to open load

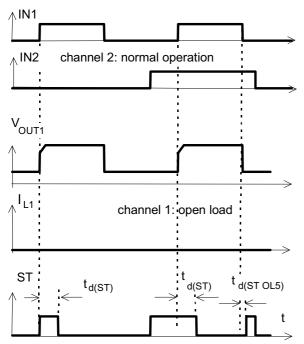


The status delay time td(STOL4) allows to distinguish between the failure modes "open load in ON-state" and "overtemperature".

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Figure 5c: Open load: detection in ON- and OFF-state (with REXT), turn on/off to open load



 $t_{d(\text{ST}\;\text{OL5})}$ depends on external circuitry because of high impedance

Figure 6a: Undervoltage:

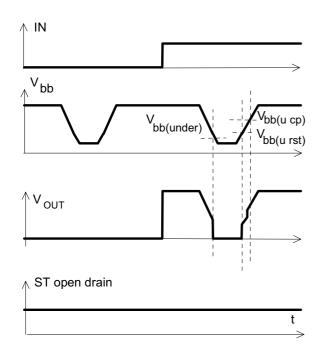
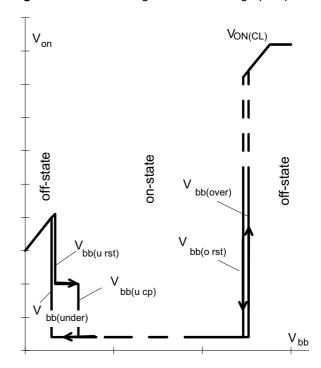
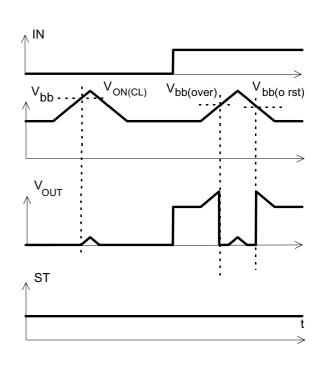


Figure 6b: Undervoltage restart of charge pump



IN = high, normal load conditions. Charge pump starts at $V_{bb(ucp)}$ = 5.6 V typ.

Figure 7a: Overvoltage:



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Package Outlines

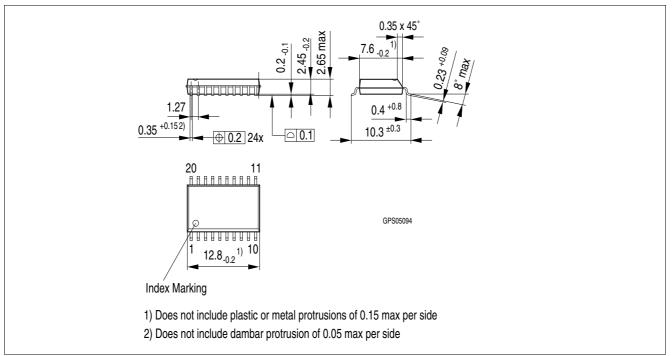


Figure 1 PG-DSO-20-31 / PG-DSO-20-59 (Plastic Dual Small Outline Package) (RoHS-compliant)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order

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Revision History

Version	Date	Changes					
Rev. 1.3	2012-01-16	page 16: added package variant PG-DSO-20-59					
Rev. 1.2	2010-03-16	age 6: changed reference to the timing diagram					
Rev. 1.1	2009-07-13	page 1: added new coverpage page 6: Initial short circuit shutdown time changed: $t_{\rm off(SC)}$ -40 °C to 48 ms $t_{\rm off(SC)}$ 25 °C to 29 ms					
V1.0	2008-04-18	Creation of the Green Data sheet					

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Edition 2012-01-16

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